

SMPP Series Rev. V27

Features

- Low Loss, High Isolation Switching Diodes
- Low Distortion Attenuator Diodes
- Single and Dual Diode Configurations
- Tape & Reel Packaging
- Lead-Free Surface Mount Packages
- RoHS* Compliant

Description and Applications

MACOM offers silicon PIN diodes in five standard, low cost, surface mount plastic packages for use as switches and attenuators. These diodes are offered with 100% matte Sn plating. These PIN diodes feature a variety of I-region lengths resulting in lower resistance, and lower capacitance devices for various microwave control circuit applications.

The MA4P7436, and MADP-007436 series offer the lowest series resistance for best performance as low loss series switches and high isolation shunt switches.

The MA4P7433, and MADP-007433 series have the lowest capacitance and offers the highest isolation in series and series-shunt switches through 3 GHz.

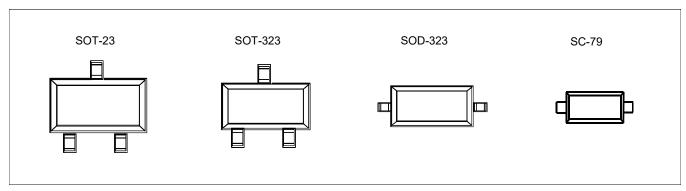
The MA4P7447, MADP-007155 series, MA4P7455, MADP-007455 series and the MADP-007448 series are general purpose PIN diodes useful as either switches or attenuators.

The MA4P7437, MADP-007437 series and MA4P7438, MADP-007438 series device have thicker intrinsic regions to provide lower distortion in attenuator circuits.

The MADP-007167 series devices have the thickest I-Region, offering the lowest distortion and highest IP3 for current controlled attenuator circuits. These devices are ideal for AGC functions for infrastructure and CATV applications.

These parts are available as single diodes, series tees (ST), series tee reverse (STR), common cathode pairs (CK), and common anode pairs (CA). MACOM's PIN diodes are available in the SOT-23 (case style 287), the SOT-323/SC-70(3L) (case style 1146), the SOD-323 (case style 1141), and the SC-79 (case style 1279) packages. These packages are supplied on tape and reel for automatic pick and place assembly. The tape and reel suffix designation is a "T" at the end of the part number.

Package Outlines



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^{*} Restrictions on Hazardous Substances, compliant to current RoHS EU directive.

Surface Mount Plastic PIN Diodes



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Electrical Specifications @ +25°C

	Reverse Voltage ¹ (V)	Total Capacitance ² Maximum (pF)	RS @ 10 mA ³ Maximum (Ohms)	Nominal Characteristics	
Part #				Carrier Lifetime⁴ (µs)	I-Region Thickness (mils)
MA4P7436 MADP-007436 Series	75	1.00 @ 20 V	0.5	0.2	0.4
MA4P7433 MADP-007433 Series	75	0.35 @ 20 V	1.5	0.2	0.4
MA4P7447 MADP-007155 Series	100	1.20 @ 20 V	0.6	1.0	0.8
MADP-007448 Series	100	0.25 @ 50 V	2.0	0.4	0.6
MA4P7455 MADP-007455 Series	100	0.35 @ 50 V	3.0	1.0	2.0
MA4P7437 MADP-007437 Series	200	0.35 @ 50 V	6.0	2.0	4.0
MA4P7438 MADP-007438 Series	200	0.35 @ 50 V	10.0	3.0	5.0
MADP-007167	200	0.30 @ 50 V	16.0	3.0	7.0
MADP-011192	500	0.50 @ 50 V	2.5	1.2	1.7

^{1.} The reverse current will not exceed 10 μ A at the reverse voltage rating.

Absolute Maximum Ratings @ +25°C⁵ (Unless Otherwise Noted)

Parameter	Rating	
Operating Temperature		
Storage Temperature	-65°C to +150°C	
Junction Temperature	+175°C	
RF CW Incident Power: MA4P7447, MADP-007155 Series (θ die = 15°C/W), RF & DC Incident De-rating Coefficient = -21.3 mW/°C MA4P7436, MADP-007436 Series (θ die = 25°C/W), RF & DC Incident De-rating Coefficient = -16.8 mW/°C MA4P7438, MADP-007438Series (θ die = 30°C/W), RF & DC Incident De-rating Coefficient = -13.3 mW/°C MA4P7455, MADP-007455 Series (θ die = 35°C/W), RF & DC Incident De-rating Coefficient = -13.3 mW/°C MA4P7437, MADP-007437 Series (θ die = 45°C/W), RF & DC Incident De-rating Coefficient = -13.3 mW/°C MADP-007167 Series (θ die = 55°C/W), RF & DC Incident De-rating Coefficient = -10.7 mW/°C MA4P7433, MADP-007433 Series (θ die = 80°C/W), RF & DC Incident De-rating Coefficient = -10.7 mW/°C MADP-007448 Series (θ die = 80°C/W), RF & DC Incident De-Rating Coefficient = -13.3 mW/°C	32 dBm 31 dBm 30 dBm 30 dBm 30 dBm 30 dBm 29 dBm 32 dBm 29 dBm	
Total (RF + DC) Power Dissipation: (SOT-23,): RF & DC Dissipated De-rating Coefficient = -33.3 mW/°C (SOT-323, SOD-323, SC-79): RF & DC Dissipated De-rating Coefficient = -26.7 mW/°C	250 mW 200 mW	
Reverse Voltage Forward Current	Voltage Rating 150 mA DC	

^{5.} Operation of these devices above any one of these parameters may cause permanent damage.

^{2.} Total capacitance is measured at 1 MHz at the indicated voltage.

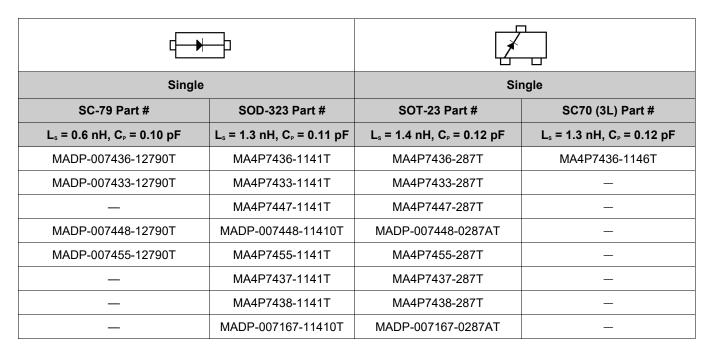
^{3.} Series resistance is measured at the specified current and a frequency of 100 MHz.

^{4.} Nominal minority carrier lifetime is measured at I_F = 10 mA, I_R = 6 mA, 90% recovery.



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Packaging and Configurations

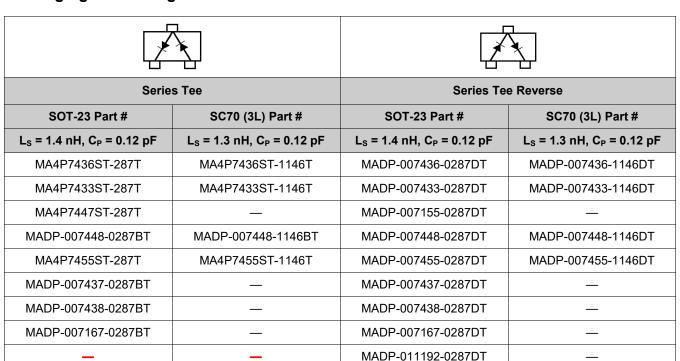


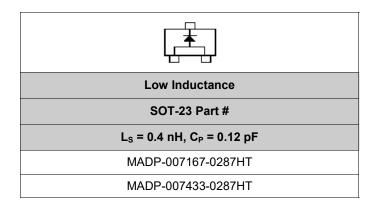
Common Cathode		Common Anode		
SOT-23 Part #	SOT-23 Part # SC70 (3L) Part #		SC70 (3L) Part #	
L _S = 1.4 nH, C _P = 0.12 pF	L _S = 1.3 nH, C _P = 0.12 pF	L _S = 1.4 nH, C _P = 0.12 pF	L _S = 1.3 nH, C _P = 0.12 pF	
MA4P7436CK-287T	MA4P7436CK-1146T	MA4P7436CA-287T	MA4P7436CA-1146T	
MA4P7433CK-287T	MA4P7433CK-1146T	MA4P7433CA-287T	MA4P7433CA-1146T	
MA4P7447CK-287T	_	MA4P7447CA-287T	_	
MADP-007448-0287FT	_	MADP-007448-0287GT	MADP-007448-1146GT	
MA4P7455CK-287T	MA4P7455CK-1146T	MA4P7455CA-287T	MA4P7455CA-1146T	
MADP-007437-0287FT	_	MA4P7437CA-287T	_	
MADP-007438-0287FT	_	MA4P7438CA-287T	_	
MADP-007167-0287FT	_	MADP-007167-0287GT	_	



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Packaging and Configurations



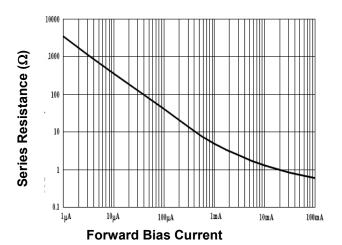




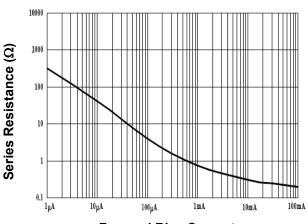
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Typical Forward Resistance vs. DC Bias Current Curves @ 100 MHz

Resistance vs. Forward Current (MA4P7455 /MADP-007155 Series)

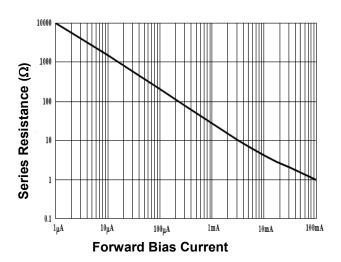


Resistance vs. Forward Current (MA4P7436 /MADP-007436 Series)

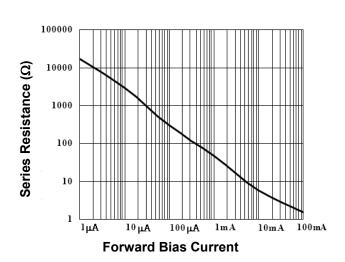


Forward Bias Current

Resistance vs. Forward Current (MA4P7437 /MADP-007437 Series)



Resistance vs. Forward Current (MA4P7438 /MADP-007438 Series)



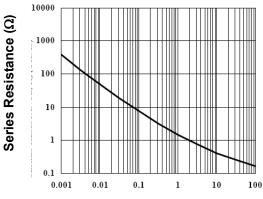
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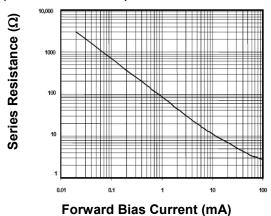
Typical Forward Resistance vs. DC Bias Current Curves @ 100 MHz

Resistance vs. Forward Current (MA4P7447 / MADP-007155 Series)

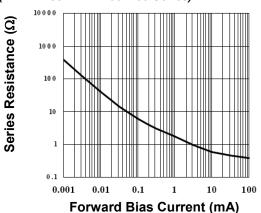


Forward Bias Current (mA)

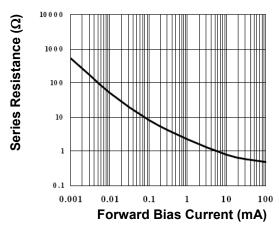
Resistance vs. Forward Current (MADP-007167 Series)



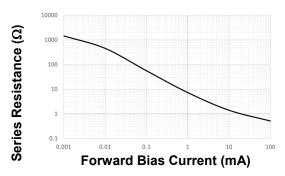
Resistance vs. Forward Current (MA4P7433/ MADP-007433 Series)



Resistance vs. Forward Current (MADP-007448 Series)



Resistance vs. Forward Current (MADP-011192 Series)



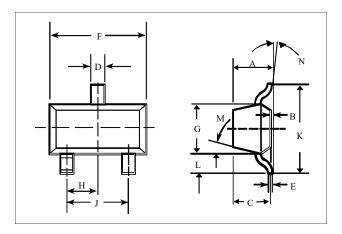
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Case Styles

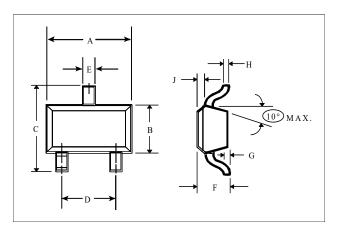
SOT-23 (Case Style 287)



DIM	DIM. INCHES		MILLIM	ETERS
DIN.	MIN.	MAX.	MIN.	MAX.
Α	_	0.048	_	1.22
В	_	0.008	_	0.20
С	_	0.040	_	1.00
D	0.013	0.020	0.35	0.50
Е	0.003	0.006	0.08	0.15
F	0.110	0.119	2.80	3.00
G	0.047	0.056	1.20	1.40
Н	0.037 typical		0.95 typical	
J	0.075 typical		1.90 t	ypical
K	_	0.103	_	2.60
L	_	0.024	_	0.60
DIM.	GRADIENT			
М	10° max. ⁶			
N	2°30°			

^{6.} Applicable on all sides

SC-70, 3 Lead (Case Style 1146)



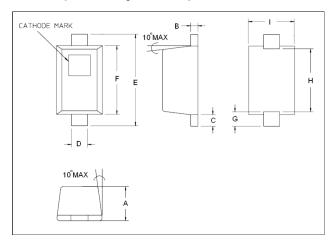
DIM.	INCHES		MILLIMETERS	
DIIVI.	MIN.	MAX.	MIN.	MAX.
Α	0.071	0.087	1.80	2.21
В	0.045	0.053	1.14	1.35
С	0.071	0.094	1.80	2.39
D	0.047	0.057	1.19	1.45
Е	0.010	0.016	0.25	0.41
F	0.031	0.039	0.79	1.00
G	0.000	0.004	0.00	0.10
Н	0.004	0.007	0.10	0.18
J	0.004	0.010	0.10	0.25



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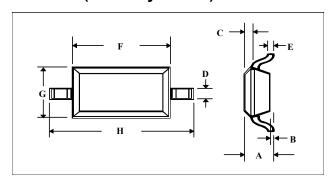
Case Styles (Cont'd)

SC-79 (Case Style 1279)



DIM.	INCHES		MILLIMETERS	
DIIVI.	MIN.	MAX.	MIN.	MAX.
Α	0.0197	0.0276	0.50	0.70
В	0.003	0.008	0.07	0.20
С	0.006	0.010	0.15	0.25
D	0.010	0.014	0.25	0.35
Е	0.059	0.067	1.50	1.70
F	0.043	0.051	1.09	1.30
G	0.0098 nominal		0.250 nominal	
Н	0.0433 nominal		1.10 nominal	
I	0.027	0.035	0.68	0.89

SOD-323 (Case Style 1141)



DIM.	INCHES		MILLIMETERS	
Dilvi.	MIN.	MAX.	MIN.	MAX.
Α	_	0.043	_	1.1
В	_	0.004	_	0.1
С	_	0.008	_	0.2
D	0.010	0.016	0.25	0.41
E	0.003	0.006	0.07	0.15
F	0.063	0.075	1.6	1.9
G	0.045	0.057	1.14	1.45
Н	0.091	0.106	2.3	2.7



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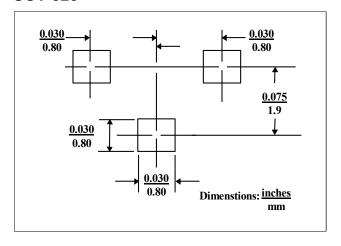
Mounting Information

The illustration indicates the recommended mounting pad configuration for the SOT-23, SOT-323, SOD-323, and SC-79 packages. Solder paste containing flux should be screened onto the pads to a thickness of 0.005- 0.007 inches. The plastic package is placed in position, firmly adhering to the solder paste.

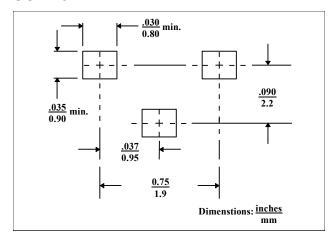
Permanent attachment is performed by a reflow soldering procedure during which the tab temperature does not exceed +275°C and the body temperature does not exceed +250°C, for standard models and +260°C for the RoHS compliant devices.

Please refer to Application Note M538 for surface mounting instructions.

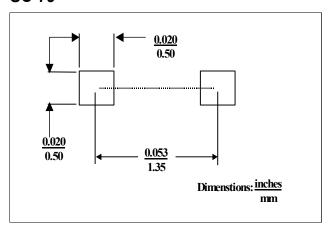
SOT-323



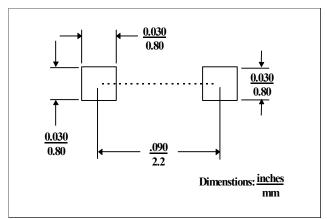
SOT-23



SC-79



SOD-323



Surface Mount Plastic PIN Diodes



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